

## Small Signal Schottky Diodes

### Features

- The SD103 series is a Metal-on-silicon Schottky barrier device which is protected by a PN junction guard ring.
- The low forward voltage drop and fast switching make it ideal for protection of MOS devices, steering, biasing and coupling diodes for fast switching and low logic level applications.
- Other applications are click suppression, efficient full wave bridges in telephone subsets, and blocking diodes in rechargeable low voltage battery systems.
- These diodes are also available in the SOD123 and SOD323 case with type designations SD103AW(S)-V...SD103CW(S)-V, and in the MiniMELF case with type designations LL103A thru LL103C.
- For general purpose applications
- Lead (Pb)-free component
- Component in accordance with RoHS2002/95/EC and WEEE 2002/96/EC



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### Applications

- HF-Detector
- Protection circuit
- Small battery charger
- AC-DC/DC-DC converters

### Mechanical Data

**Case:** DO35 Glass case

**Weight:** approx. 125 mg

**Cathode Band Color:** black

**Packaging Codes/Options:**

TR/10 k per 13" reel (52 mm tape), 50 k/box

TAP/10 k per Ammpack (52 mm tape), 50 k/box

### Parts Table

Part	Type differentiation	Ordering code	Type Marking	Remarks
SD103A	$V_R = 40\text{ V}$	SD103A-TR or SD103A-TAP	SD103A	Tape and Reel/Ammpack
SD103B	$V_R = 30\text{ V}$	SD103B-TR or SD103B-TAP	SD103B	Tape and Reel/Ammpack
SD103C	$V_R = 20\text{ V}$	SD103C-TR or SD103C-TAP	SD103C	Tape and Reel/Ammpack

### Absolute Maximum Ratings

$T_{amb} = 25\text{ }^\circ\text{C}$ , unless otherwise specified

Parameter	Test condition	Part	Symbol	Value	Unit
Peak inverse voltage		SD103A	$V_R$	40	V
		SD103B	$V_R$	30	V
		SD103C	$V_R$	20	V
Power dissipation (infinite heatsink)			$P_{tot}$	400 <sup>1)</sup>	mW
Single cycle surge 60 Hz sine wave			$I_{FSM}$	15	A

<sup>1)</sup> Valid provided that leads at a distance of 4 mm from case are kept at ambient temperature

### Thermal Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Thermal resistance junction to ambient air		$R_{thJA}$	310 <sup>1)</sup>	K/W
Junction temperature		$T_j$	125 <sup>1)</sup>	$^{\circ}\text{C}$
Storage temperature range		$T_{stg}$	- 55 to + 150 <sup>1)</sup>	$^{\circ}\text{C}$

<sup>1)</sup> Valid provided that leads at a distance of 4 mm from case are kept at ambient temperature

### Electrical Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

Parameter	Test condition	Part	Symbol	Min	Typ.	Max	Unit
Reverse Breakdown Voltage	$I_R = 50\text{ }\mu\text{A}$	SD103A	$V_{(BR)}$	40			V
		SD103B	$V_{(BR)}$	30			V
		SD103C	$V_{(BR)}$	20			V
Leakage current	$V_R = 30\text{ V}$	SD103A	$I_R$			5	$\mu\text{A}$
	$V_R = 20\text{ V}$	SD103B	$I_R$			5	$\mu\text{A}$
	$V_R = 10\text{ V}$	SD103C	$I_R$			5	$\mu\text{A}$
Forward voltage drop	$I_F = 20\text{ mA}$		$V_F$			370	mV
	$I_F = 200\text{ mA}$		$V_F$			600	mV
Diode capacitance	$V_R = 0\text{ V}$ , $f = 1\text{ MHz}$		$C_D$		50		pF
Reverse recovery time	$I_F = I_R = 50\text{ to }200\text{ mA}$ , recover to $0.1 I_R$		$t_{rr}$		10		ns

### Typical Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

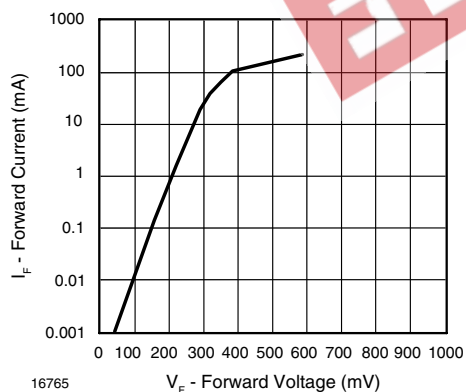


Figure 1. Forward Current vs. Forward Voltage

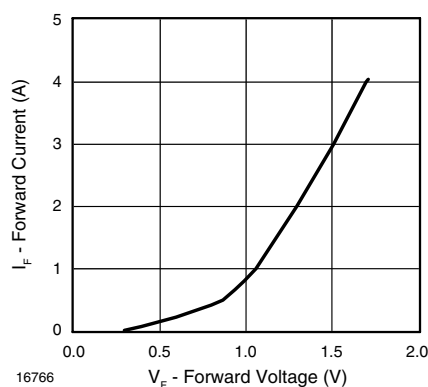


Figure 2. Forward Current vs. Forward Voltage

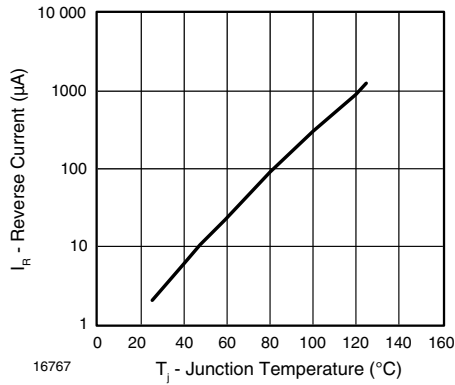


Figure 3. Reverse Current vs. Junction Temperature

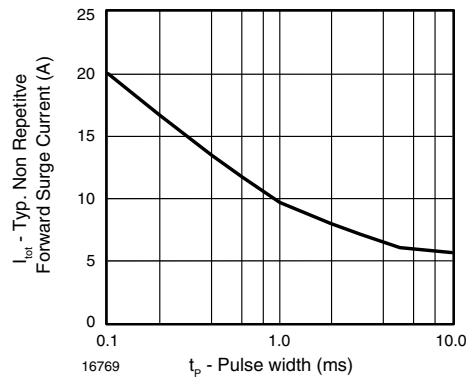


Figure 5. Typ. Non Repetitive Forward Surge Current vs. Pulse Width

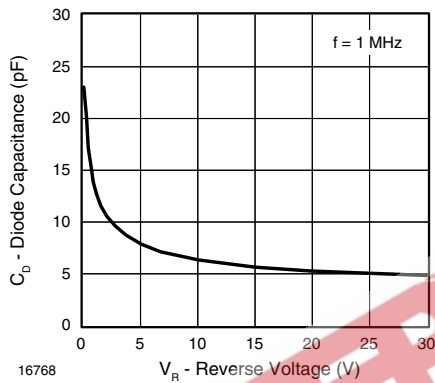
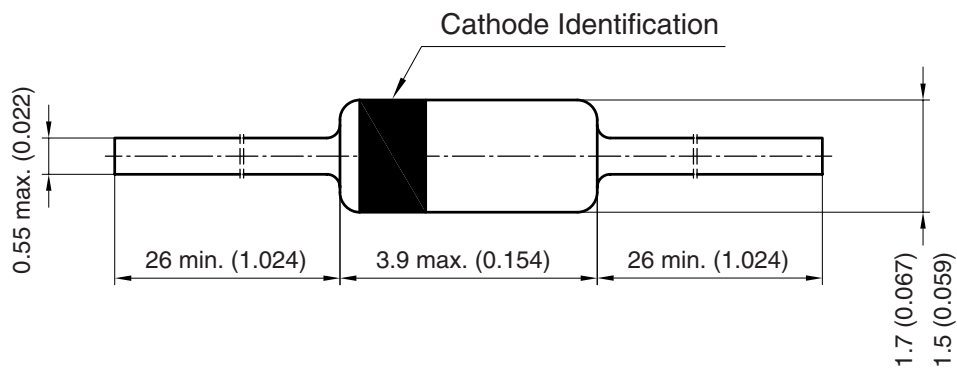


Figure 4. Diode Capacitance vs. Reverse Voltage

## Package Dimensions in millimeters (inches): DO35



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 94 9366

### Ozone Depleting Substances Policy Statement

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1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

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